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1. Name of conveying party(ies): (List using letters or numbers for multiple parties)

Bong Jae Lee; Kyung Tae Kim; Sung Sig Min;
Jong Cheol LimAdditional name(s) of conveying party(ies)
attached?

() Yes (X) No

3. Nature of conveyance:

(X) Assignment () Security Agreement
() Merger () Change of Name
() Other:Execution Date: (List as in section 1 if multiple
signatures)

All signed on October 26, 2005

Name: Cheil Industries, Inc.

Street Address: 290 Gongdan-dong, Gumi-shi

City: Gyungsangbuk-do

Country: Republic of Korea ZIP: 730-710

Additional name(s) of receiving party(ies) attached?

() Yes (X) No

4. US or PCT Application number(s) or US Patent
number(s):

(X) Application(s) filed herewith

Additional numbers attached?

() Yes (X) No

5. Party to whom correspondence concerning
document should be mailed:

Customer No. 20,995

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Attorney's Docket No.: CHEDKC.001AUS

6. Total number of applications and patents
involved: 1

7. Total fee (37 CFR 1.21(h)): \$40

(X) Enclosed

8. Deposit account number: 11-1410

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy
is a true copy of the original document.Mincheol Kim

Name of Person Signing

Signature

October 27, 2005
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Application No.: Unknown
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PATENT
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Page 1

ASSIGNMENT

WHEREAS, We, the undersigned, have invented certain new and useful improvements in a **POLYCARBONATE RESIN COMPOSITION AND MOLDED ARTICLES WITH THE SAME** for which we have executed an application for Letters Patent in the United States, on even date herewith;

AND WHEREAS, Cheil Industries, Inc. (hereinafter "ASSIGNEE"), a Korean corporation with its principal place of business at 290 Gongdan-dong, Gumi-shi, Gyung-sangbuk-do 730-710 Korea, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in view of valuable considerations, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE DO HEREBY sell, assign, transfer, and convey to ASSIGNEE, his successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of the said Letters Patent before or after issuance.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

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